# Nihon Inter Electronics Corporation

## FRD MODULE 100A/200V/trr:90nsec

# PC100F2

**OUTLINE DRAWING** 

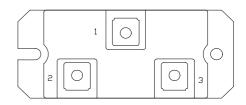
### **FEATURES**

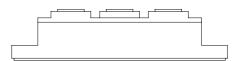
- \* Isolated Base
- \* Dual Diode Cathode Common
- \* Ultra Fast Recovery
- \* High Surge Capability
- \* UL Recognized, File No. E187184

### TYPICAL APPLICATIONS

\* High Frequency Rectification







### Maximum Ratings

### Approx Net Weight:210g

Voltage Rating	Symbol	PC100F2		Unit
Repetitive Peak Reverse Voltage per Arm	Vrrm	200		V
Electrical Rating		Condition	Rating	
Average Rectified Output Current	Io	50Hz Half Sine Wave condition per Arm Tc=99°C	100	A
RMS Forward Current	I <sub>F</sub> (RMS)	per Arm	157	Α
Surge Forward Current	L CCM	50 Hz Half Sine Wave,1cycle Non-repetitive per Arm	1800	A
I Squared t	I2t	2 msec to 10 msec per Arm	16200	$A^2s$
Operating JunctionTemperature Range	Tjw		-40 to +150	°C
Storage Temperature Range	Tstg		-40 to +125	°C
Isoration Voltage	Viso	Base Plate to Terminal, AC1min	2000	V
Mounting torque	Ftor	Case mounting(recommended)	2.6	N•m
		Terminal Screw(recommended)	1.4	

### **Electrical** • Thermal Characteristics

Characteristics	Symbol	Test Conditions	Max.	Unit	
Peak Forward Voltage	$V_{\rm FM}$	I <sub>FM</sub> = 100A, Tj=25°C, per Arm	1.0	V	
Peak Reverse Current	$I_{RM}$	V <sub>RM</sub> = V <sub>RRM</sub> , Tj= 150°C, per Arm	10	mA	
Reverse Recovery Time	trr	$I_{FM}$ = 10A, -di/dt= 50 A/ $\mu$ s, Ta= 25°C Per Arm	90	ns	
Thermal Resistance	Rth(j-c)	Junction to Case per Arm	0.5	°C/W	
	Rth(c-f)	Base Plate to Heat Sink with Thermal Compound	0.1		
Internal Lead Inductance	1 6	Anode Terminal to Cathode Terminal Per Element	30	nН	

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## PC100F2 OUTLINE DRAWING (Dimensions in mm)

